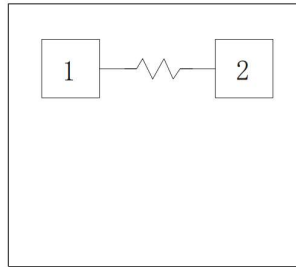


### Features

- Withstand high current
- Small size
- Can customize according to requirements

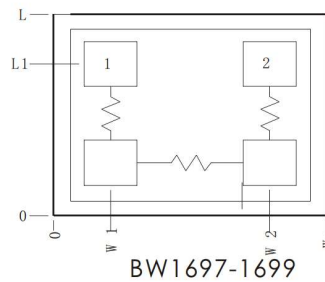
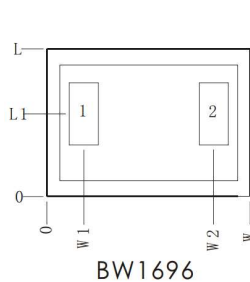
### Function Diagram



### Electrical Specifications (Ta=+25°C, 50Ω system)

Part Number	W	W1	W2	L	L1	Standard Resistance (Ω)	Handling Power
	um	um	um	um	um		
BW1696	1050	190	860	600	340	100	10
BW1697	1050	220	830	900	680	200	12
BW1698	1050	220	840	1350	1130	420	16
BW1699	1050	220	830	1450	1230	470	17

### Outline Size



### Note:

1. Unit: um
2. Bottom side is gold plated
3. Bottom side is GND
4. Bonding pads is gold plated, Pad size: BW1696, 150\*250(um) BW1697~BW1699, 200\*200(um)
5. Don't bonding on thru holds
6. Tolerance: ±50um

### Bonding Definition

Number	Symbol	Description
1、2	In, Out	Input and output ports
	GND	Bottom must be grounded

### Absolute Rating

Max. Handling Power	10W
Junction Temperature	175°C
Storage Temperature	-65~+150°C
Operating Temperature	-55~+125°C
Static Protection (HBM)	Class 1A



### Application

